3 × 2.7mm Compact High Operating Force (Surface Mount Type)

Heavy-operational and equipped with a 1.4mm tall stem and grounding, meeting in-car needs





Typical Specifications		
Items	Specifications	
Rating (max.)	50mA 12V DC	
Rating (min.)	10µA 1V DC	
Initial contact resistance	100mΩ max.	
Travel (mm)	0.12	

Product Line

Top push type

Product No. Operating force		Operating direction	Direction Operating life	Otom color	Minimum order unit (pcs.)	
			(5mA 5V DC)	(5mA 5V DC) Stem color		Export
SKSGACE010	1.6N	Top push	200,000 cycles	Natural	12,000	12,000
SKSGAAE010	4N	TOP Push		Black		

With ground terminal type

Product No.	Operating force	Operating direction	Operating life (5mA 5V DC)	Stem color	Minimum ord Japan	er unit (pcs.) Export
SKSGPCE010	1.6N	Top puch	200,000 cycles	Natural	12,000	12,000
SKSGPAE010	4N	Top push		Black		

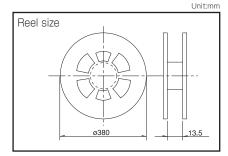
Packing Specifications

Taping

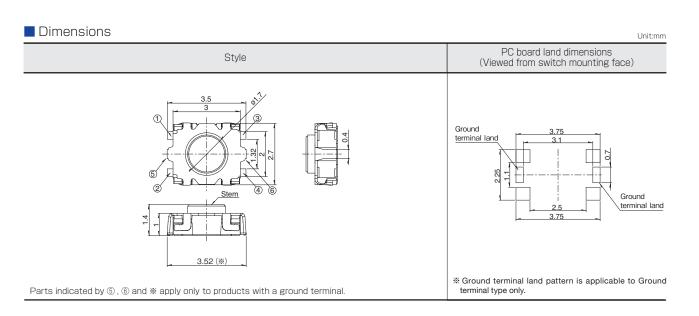
Number of packages (pcs.)			Tape width	Export package
1 reel	1 case / Japan	1 case / export packing	(mm)	measurements (mm)
12,000	120,000	120,000	12	395×395×205

Note

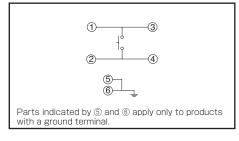
For reels of 330mm diameter, please inquire.







Circuit Diagram





	Туре					arp Feeling Ty Gurface Moun				
	Series	SKSD	SKRN	SKTA	SKSV	SKSW	SKSF	SKSM	SKTK	SKSG
	Photo	A.C.W	\diamond	NEW			٢	٢	NEW	
	Features	Double	e action			Compact size Low-profile	9		Long life	High operati force Compact si
	Water-proof		_	•	•	•	_	•	•	_
	Dust-proof	_	_	•	•	•	_	•	•	_
	IP standard	_	_	67 equivalency	67 equivalency	67 equivalency 68 equivalent in some cases	_	67 equivalency	67 equivalency	_
Operatir	Top push	•	•	•	•	•	•	•	•	•
directic			_	_	_	_	_	_	_	_
	W	4.1		2.6	2.8	3	2.8	3.4	5.9	3
Dimensio (mm)	ons D	3.9	□6	1.6	1.9	2	2.4	2.9	4	2.7
(11111)	Н	0.6	0.9	0.53	0.55	0.6	0.65	0.7	0.78	1.4
Operatio force coverag	2N to 3N	for respect	evant pages ive product iptions	\$	Ţ	Ţ	\$	\$	\$	^
	Travel (mm)		ant pages for luct descriptions	0.11	0.12	0.13	(D.1	0.25	0.12
G	round terminal	•	•	_	_	_	_	_	_	0
Operatir	ng temperature range	-40℃ t	:o +90℃			_	30℃ to +8!	5°C		
A	utomotive use	—	—	—	_	—	—	—	—	•
	Life Cycle									
	Rating (max.) (Resistive load)		1	1	5	iOmA 12V D	С		1	1
Electrical	Rating (min.) (Resistive load)					10µA 1V DC	;			
erformance	Insulation resistance			100MΩ min. 1	IOOV DC 1mii	٦.		50MΩ min. 100V DC 1min.		IΩ min. DC 1min.
	Voltage proof	100V AC 1min.	250V AC 1min.			1	00V AC 1m	in.		
Durability	Vibration		10	to 55 to 10 in the 3	Hz/min., the a direction of λ	amplitude is 1 (, Y and Z for	.5mm for all 2 hours res	the frequenc	ies,	
Sarability	Lifetime			Shall b	e in accordar	nce with indiv	idual specifi	cations.		
	Cold	-40°C 96h								
nvironmental erformance	Dry heat	90°C 96h								
	Damp heat	60°C, 90 to 95%RH 96h								
	Page	219	220	221	222	223	225	226	227	228
						D : Depth. 1	The most out	er dimension e er dimension o dimension if	excluding terr	ninal portio

Notes

1. The automotive operating temperature range to be individually discussed upon request.

2. • Indicates applicability to all products in the series, while \bigcirc indicates applicability to some products in the series.

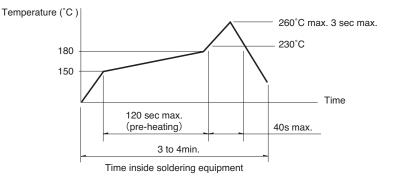
TACT Switch[™]



Condition for Reflow

Available for Surface Mount Type.

- 1. Temperature measurement: Thermocouple ϕ 0.1 to 0.2 CA (K) or CC (T) at solder joints (copper foil surface). A heat resistive tape should be used to fix thermocouple.
- 2. Temperature profile



Notes

- The above temperature shall be measured of the top of switch. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC boards and others. The above-stated conditions shall also apply to switch surface temperatures.
- Soldering conditions differ depending on reflow soldering machines.
- Prior verification of soldering condition is highly recommended.

Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	Бs max.
Number of soldering	2times max.

SKHH, SKPD Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKQJ, SKQK, SKEG Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	45s max.
Soldering temperature	255°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

Notes

1. Prevent flux penetration from the top side of the TACT Switch[™].

- 2. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 3. The second soldering should be done after the switch is stable with normal temperature.
- 4. Use the flux with a specific gravity of min 0.81.
- (EC-19S-8 by TAMURA Corporation, or equivalents.)

Manual Soldering

	<u> </u>
Items	Condition
Soldering temperature	350°C max.
Duration of soldering	Зs max.
Capacity of soldering iron	60W max.

SKHH, SKHW, SKRG, SKPD Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	Зs max.
Capacity of soldering iron	60W max.

SKTD, SKTG, SKQJ, SKQK, SKEG Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	Зs max.
Capacity of soldering iron	20W max.